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TC 1700

PATENT
29926/38060

1756

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Sung-Kwon Lee and
Sang-Ik Kim

Serial No.: 10/066,849

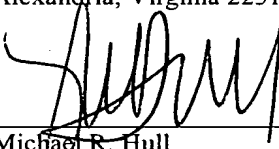
Filed: February 4, 2002

For: Method for Manufacturing Multi-
Level Interconnections with Dual
Damascene Process

Group Art Unit: 1756

Examiner: John S. Ruggles

) I hereby certify that this paper and the
) documents referred to as enclosed
) therewith are being deposited with the
) United States Postal Service as first class
) mail, postage prepaid, on **December 29,**
) **2003**, in an envelope addressed to
) Commissioner for Patents, P.O. Box 1450
) Alexandria, Virginia 22313-1450

) 
) Michael R. Hull
) Reg. No. 35,902
) Attorney for Applicants
)

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

In response to the office action mailed on September 29, 2003, please amend
the above-identified patent application as follows.